

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L1	3265	layout near5 die	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2003/06/03 15:24
		bond\$4 adj pad	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2003/06/03 14:46
		714/718,727.ccls.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/01/05 21:58
L2	203679	multiplex\$4 and (function or logic\$4)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/01/05 21:58
L3	754	L2 and 1	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/01/05 21:58
L4	0	((multiplex\$4 with probe adj pad and bond adj pad) with without near5 contact with probe).clm.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/01/05 22:00
S1	7996	layout near5 (integrated or IC!)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2003/06/03 14:44
S2	139042	multiplex\$4 and (function or logic\$4)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2003/06/03 14:45
S3	1054	(layout near5 (integrated or IC!)) and (multiplex\$4 and (function or logic\$4))	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2003/06/03 15:11
S4	1054	(layout near5 (integrated or IC!)) and (multiplex\$4 and (function or logic\$4))	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2003/06/03 15:12

S5	77	((layout near5 (integrated or IC!)) and (multiplex\$4 and (function or logic\$4))) and (bond adj pad)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2003/06/03 15:24
S6	6364	test\$4 near5 die	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2003/06/03 15:25
S7	172	(layout near5 die) and (test\$4 near5 die)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2003/06/03 15:25
S8	46	((layout near5 die) and (test\$4 near5 die)) and multiplex\$4	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2003/06/03 15:31
S9	4355	324/158.1.ccls.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2003/06/03 15:31
S10	1433	324/158.1.ccls. and (function or logic\$4)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2003/06/03 15:32
S11	191	(324/158.1.ccls. and (function or logic\$4)) and multiplex\$4	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2003/06/03 15:33
S12	67	((324/158.1.ccls. and (function or logic\$4)) and multiplex\$4) and pad	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2003/06/03 16:35
S13	72093	test\$4 near4 (module or cell)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2003/06/03 17:44
S14	1118212	integrated or IC!	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2003/06/03 17:17

S15	2090	(test\$4 near4 (module or cell)) with (integrated or IC!)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2003/06/03 17:17
S16	546	((test\$4 near4 (module or cell)) with (integrated or IC!)) and (multiplex\$4 or mux!)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2003/06/03 17:46
S17	49	((test\$4 near4 (module or cell)) with (integrated or IC!)) and (multiplex\$4 or mux!) and 324/750-765,158.1.ccls.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2003/06/03 17:46
S18	2	("3921140" "4749947").PN.	USPAT	OR	ON	2003/06/03 17:28
S19	54405	test\$4 near4 (function or logic\$4)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2003/06/03 17:45
S20	21512	(test\$4 near4 (function or logic\$4)) and (integrated or IC!)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2003/06/03 17:46
S21	4279	(test\$4 near4 (function or logic\$4)) with (integrated or IC!)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2003/06/03 17:46
S22	1067	((test\$4 near4 (function or logic\$4)) with (integrated or IC!)) and (multiplex\$4 or mux!)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2003/06/03 17:46
S23	103	((test\$4 near4 (function or logic\$4)) with (integrated or IC!)) and (multiplex\$4 or mux!) and 324/750-765,158.1.ccls.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2003/06/03 17:47
S24	15115	test\$4 near5 wafer	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2003/06/05 11:53
S25	13866	bond adj pad	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2003/06/05 11:54

S26	217	(test\$4 near5 wafer) with (bond adj pad)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2003/06/05 11:54
S27	22	((test\$4 near5 wafer) with (bond adj pad)) and (mux! or multiplex\$4)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2003/06/05 12:58
S28	466	324/763.ccls.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2003/06/05 12:15
S29	93	324/763.ccls. and (mux! or multiplex\$4)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2003/06/05 12:56
S30	33	(324/763.ccls. and (mux! or multiplex\$4)) and wafer	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2003/06/05 12:58
S31	3278	324/765.ccls.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2003/06/05 12:58
S32	198	324/765.ccls. and (mux! or multiplex\$4)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2003/06/05 12:59
S33	3882	324/763,765.ccls.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/02/11 11:10
S34	306	324/763,765.ccls. and (bond adj pad)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/02/11 11:11
S35	34	(324/763,765.ccls. and (bond adj pad)) and (probe adj pad)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/02/11 12:03

S36	97	((function or block) adj circuitry) near6 (integrated adj circuit)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/02/11 12:05
S37	5	(test\$4 or detect\$4) near5 ((function or block) adj circuitry) near6 (integrated adj circuit)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/02/11 12:05
S38	5	(test\$4 or detect\$4) near5 ((function or block) adj circuitry) with (integrated adj circuit)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/02/11 12:06
S39	1	((test\$4 or detect\$4) near5 ((function or block) adj circuitry) same (integrated adj circuit)) and (bond adj pad) and (test\$4 adj pad)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/02/11 12:06
S40	15	(test\$4 or detect\$4) near5 ((function or block) adj circuitry) same (integrated adj circuit)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/02/11 12:07
S41	4	("4336495" "4686627" "4743841" "4970454").PN.	USPAT	OR	ON	2004/02/11 12:11